Citizenship: Taiwan, R.O.C.

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

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COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

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My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

CHIP PACKAGE AND SUBSTRATE

	specification of which					
_X	is attached hereto	•				
	was filed on as Application Ser	rial No	and was amended on_			
app app forc	ecification, including I acknowledge the olication in accordan I hereby claim fore olication(s) for pater	the claims, as amended e duty to disclose infor ce with Title 37, Code of eign priority benefits und at or inventor's certificatent or inventor's certi- ned:	nd understand the content by any amendment referred mation which is material to feederal Regulations, § 1. der Title 35, United States Cate listed below and have ficate having a filing date be	d to above. the patent 56(a). code, § 119 also identif	ability of this of any foreign ed below any	
	Number	Country	Date Filed(yyyy/mm/dd)	Yes	No	
	92130893	Taiwan, R.O.C.	2003/11/5	Х		
traı		=))			
	SEND CORRESPO	NDENCE TO:		DIRECT TELEPHONE CALLS TO: (Name and telephone number)		
				da Lee		